



**Qualcomm Incorporated**

5775 Morehouse Drive, San Diego, CA 92121

6 November 2019

Ms. Susanna Kooistra  
Mr. Ingbert Sigovich  
ETSI, Mobile Competence Center (MCC)  
650, route des Lucioles  
Sophia-Antipolis  
France

Subject: Nomination of candidate for the 3GPP TSG RAN5 Vice Chairman

Dear Ms. Kooistra and Mr. Sigovich:

I am pleased to inform you that Qualcomm, through its ATIS 3GPP affiliation, is nominating Mr. Pradeep Gowda as a candidate for the position of 3GPP TSG RAN5 Vice Chairman at the upcoming election in RAN5#85 (Nov-2019).

In proposing Pradeep Gowda for the position of 3GPP TSG RAN5 Vice Chairman, Qualcomm is committed to support him in this role and to support all obligations of the Vice Chairman including time and travel commitments.

Pradeep Gowda is informed about and aware of the antitrust/competition laws and regulations of relevant jurisdictions and, if elected, he will comply with such laws while acting in his capacity as TSG RAN5 Vice- Chairman.

A brief curriculum vitae of Pradeep Gowda is attached.

Best Regards,

A handwritten signature in black ink, reading "Edward G. Tiedemann, Jr.", with a stylized flourish at the end.

Edward G. Tiedemann, Jr.  
Senior Vice-President, Engineering  
QUALCOMM Technologies, Inc.



## **Pradeep Gowda**

Pradeep has been working at QUALCOMM since 2001 and has been involved in RF and Layer1 conformance testing of LTE, CDMA2000, WCDMA and GERAN chipsets. For the last 18 years he has been leading RF and Layer1 system testing activities, coordinating and planning Layer1 and RF verification activities with cross functional teams (involving Systems, SW and HW engineers).

In November 2008, he started attending TSG RAN WG5 meetings and has been actively contributing to RF and Layer1 aspects of HSPA, DC-HSDPA, LTE specifications over the last 11 years. During this time, he actively contributed and enabled the completion of several RAN5 LTE and HSPA Work items. In the last 2 years he has taken an active role in enabling progress of the 5G-NR 3GPP RF/RRM specifications.

Currently Pradeep is the Vice Chairman of the TSG RAN WG5, and has completed three consecutive terms as RAN WG5 Vice Chairman. During this time, he has been chairing the RF/RRM sessions in his role as RAN5 RF/RRM Subgroup Convener.

Pradeep graduated in 2001 with a Master's degree in Electrical Engineering from State University of New York Buffalo, USA.